### SanKen

# SLA707xM Series

February, 2006

#### **■**General Description

Combining low-power CMOS logic with high-current, high-voltage power FET outputs, the Series SLA707xM translator/drivers provide complete control and drive for a two-phase unipolar stepper motor with internal fixed off time and pulse-width modulation (PWM) control of the output current in a power multi-chip module (PMCMTM)

There are no phase-sequence tables, high-frequency control lines, or complex interfaces to program. The CMOS logic section provides the sequencing logic, direction, control, synchronous/asynchronous PWM operation, and a "sleep" function. The minimum CLOCK input is an ideal fit for applications where a complex  $\mu P$  is unavailable or overburdened. TTL or LSTTL may require the use of appropriate pull-up resistors to ensure a proper input-logic high. For PWM current control, the maximum output current is determined by the user's selection of a reference voltage and sensing resistor. The NMOS outputs are capable of sinking up to 1, 1.5, 2, or 3 A (depending on device) and withstanding 46 V in the off state.

Clamp diodes provide protection against inductive transients. Special power-up sequencing is not required.

Full-, and Half-step operation are externally selectable for the SLA7070/71/72/73MR. Full-, Half-, quarter-, and eighth-, and sixteenth-step operation are externally selectable for the SLA7075/76/77/78MR.

Half-step excitation alternates between the one-phase and two-phase modes (A-AB-B-AB-A-AB-BAB), providing an eight-step sequence.

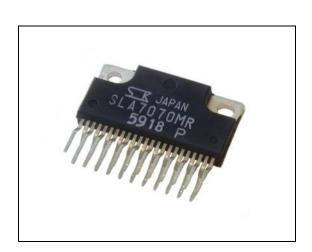
### **■**Applications

- PPC
- Printer
- OA Equipment

#### **■**Features

- To 3 A Output Rating
- Internal Sequencer for Microstepping Operation
- PWM Constant-Current Motor Drive
- Cost-Effective, Multi-Chip Solution
- 100 V, Avalanche-Rated NMOS Outputs
- Low RDS(on) NMOS Outputs (150 milliohms typical)
- Advanced, Improved Body Diodes
- Inputs Compatible with 3.3 V or 5 V Control Signals
- Sleep Mode
- Internal Clamp Diodes

#### ■Package—SLA23Pin



### **■**Key Specifications

- Motor Supply Voltage (VM): 44V max
- Load Supply Voltage (Vs): 10V to 44V
- Logic Supply Voltage (Vcc): 3V to 5.5V
- Output Current (Io): 1A(SLA7070MxRxx, SLA7075MxRxx)

1.5 A (SLA7071 Mx Rxx, SLA7076 Mx Rxx)

2A(SLA7072MxRxx, SLA7077MxRxx)

3A(SLA7073MxRxx, SLA7078MxRxx)

The x represents P, W, or R according to the functions (See App Note).

• Output Maximum Voltage (V<sub>DSS</sub>): 100V min

### **Typical Connection** Vs=10V~44V VBB Clock CW/CCW Ь м1 SLA707xMR M2 5 мз Sync N.C. Ref/Sleep1 r2≹ r3≷ Power Ground Logic Ground Ground

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#### Scope

The present specifications shall apply to a micro-stepping capable 2-phase unipolar stepper motor driver IC, SLA7077MR and shall apply to the devices compliant with RoHS Directive. Lead part solder: Pb free. Inner solder: Containing Pb > 85%.

#### **Outline**

Туре	Hybrid integrated circuit				
Structure	Plastic molded (transfer mold)				
Applications	To drive a 2-phase stepper motor. (Micro-Stepping Capable. PWM Constant-Current Control.)				

### Absolute maximum ratings

Parameter	Symbol	Ratings	Unit	Remarks
Load Supply Voltage	$V_{\mathrm{M}}$	46	V	
Main Power Supply Voltage	$V_{BB}$	46	V	
Logic Supply Voltage	$V_{ m DD}$	7	V	
Output Current	$I_{O}$	2.0*	A	Vref=0.4V, Mode F
Logic Input Voltage	$V_{\rm IN}$	-0.3 to V <sub>DD</sub> +0.3	V	
REF Input Voltage	$V_{REF}$	-0.3 to V <sub>DD</sub> +0.3	V	
Sense Voltage	VRS	±2	V	Except for tw<1µs
Dower Dissination	DL	4.7	W	At Ta=25°C
Power Dissipation	PD	17	W	At Tc=25°C
Junction Temperature	Tj	150	°C	
Operating Temperature Range	Та	-20 to 85	°C	
Storage Temperature Range	Tstg	-30 to 150	°C	

<sup>\*</sup>Output current rating may be limited by duty cycle, ambient temperature, and heat sinking. Under any conditions, do not exceed the specified junction temperature( $T_i$ ).

<sup>\*</sup> Please refer to the electric characteristics in the application note for other devices of the series.

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#### **Electrical characteristics**

Recommendable Operating Range

Doromotor	Crimbal	Ratings		Unit	Damada
Parameter	Symbol	MIN	MAX	Onit	Remarks
Load Supply Voltage	$V_{\rm M}$		44	V	
Main Power Supply Voltage Range	$V_{BB}$	10	44	V	
Logic Supply Voltage Range	$V_{DD}$	3.0	5.5	V	Please adjust the Vcc surge voltage to 0.5V or less.
REF Input Voltage Range	$V_{REF}$	0.04	0.4	V	The control current accuracy decreases in 0.1V or less.
Case Temperature	$T_{\rm C}$		90	°C	12Pin temperature (With no Fin)

Electrical Characteristic (T<sub>a</sub>=25°C, V<sub>BB</sub>=24V, V<sub>DD</sub>=5V Unless Otherwise Noted.)

Donomoston	Commission 1		Limits			Test Condition	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	
Main Power Supply Current	$I_{BB}$			15	mA	Regularity	
Main Fower Supply Current	$I_{BBS}$			100	μΑ	at SLEEP operation	
Logic Supply Current	$I_{DD}$			5	mA		
Drain-Source Breakdown	V	100			V	$V_{BB}=44V$	
Diani-Source Breakdown	$V_{(BR)DS}$	100			V	$I_D=1mA$	
Output On Resistance	R <sub>DS(on)</sub>		0.25	0.4	Ω	Io=2A	
Body Diode Forward Voltage	$V_{\rm F}$		0.95	1.2	V	Io=2A	
Maximum Clock Frequency	$f_{clk}$	250*			kHz	duty=50%	
Logic Input Voltage	$V_{LIL}$			$0.25~\mathrm{V_{DD}}$	V		
Logic input voltage	$V_{LIH}$	$0.75V_{DD}$			V		
Logic Input Current	$I_{LIL}$		±1		μΑ		
Logic input Current	$I_{LIH}$		±1		μΑ		
REF Input Voltage Range	$V_{REF}$	0		0.45	V	Stationary current control	
KET input voitage Kange	$V_{REFS}$	2.0		$V_{DD}$	V	at SLEEP operation	

<sup>\*</sup>Operation at a step frequency greater than the specified minimum value is possible but not warranted.

Note.

Negative current is defined as the outflowing current from the specified pin.

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REF Input Current	$I_{REF}$		±10		μA	$V_{REF}=0$ to $V_{DD}$
Logic Output Voltage	$V_{LOL}$			1.25	V	$I_{LOL} = 1.25 \text{mA}$
Logic Output voltage	$V_{LOH}$	$V_{DD}$ -1.25			V	$I_{LOH} = -1.25 \text{mA}$
Logio Output Current	$I_{LOL}$			1.25	mA	
Logic Output Current	$I_{LOH}$	-1.25			mA	

Operation at a step frequency greater than the specified minimum value is possible but not warranted.

Note.

Negative current is defined as the outflowing current from the specified pin.

Electrical Characteristic(continued) (T<sub>a</sub>=25°C,V<sub>BB</sub>=24V,V<sub>DD</sub>=5V Unless Otherwise Noted.)

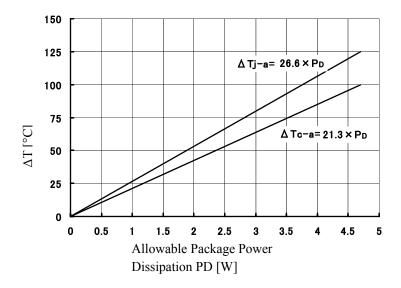
Characteristic Continued		, 55	Limits			Test Condition
Characteristic	Symbol	Min.	Тур.	Max.	Unit	
Sense Voltage	$V_{SENSE}$		0.3		V	V <sub>REF</sub> =0.3V Mode F
Current detection Resistance	Rs	0.199	0.205	0.211	Ω	
	Mode F		100		%	
	Mode E		98.1		%	
	Mode D		95.7		%	
	Mode C		92.4		%	
	Mode B		88.2		%	
	Mode A		83.1		%	
	Mode 9		77.3		%	$V_{REF}=0.04V$ to
Step Reference Current Ratio	Mode 8		70.7		%	0.4V
	Mode 7		63.4		%	
	Mode 6		55.5		%	
	Mode 5		47.1		%	
	Mode 4		38.2		%	
	Mode 3		29.0		%	
	Mode 2		19.5		%	
	Mode 1		9.8		%	
Wake-Up time	$t_{ m SE}$	100			μs	Sleep1 & Sleep2
Switching Time	$t_{pdon}$		2.0		μs	Clock→Out ON
Switching Time	$t_{ m pdoff}$		1.5		μs	Clock→Out OFF
PWM Minimum On Time	t <sub>ON(min)</sub>		1.7		μs	
	t <sub>OFF1</sub>		12		μs	Mode 8 to F
PWM OFF Time	t <sub>OFF2</sub>		9		μs	Mode 4 to 7
	t <sub>OFF3</sub>		7		μs	Mode 1 to 3

Note.

<sup>•</sup> Negative current is defined as coming out of the specified pin.

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### Thermal Design Data



#### Truth Table

### • Input Pin

Name	Low Level	High Level	Clock
Reset	Run	Logic Reset	-
CW/CCW	Forward (CW)	Reverse(CCW)	
M1			
M2	Micro-Stepping Ope	<b>_</b>	
M3			
Ref		Sleep Mode 1*	-
Sync	Asynchronous PWM Operation	Synchronous PWM Operation	-

<sup>\*</sup> With a setup of a sleep mode 1, the operation is "Output Disable" and "Sequencer Enable"

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#### Micro-Stepping Operation Mode Setting

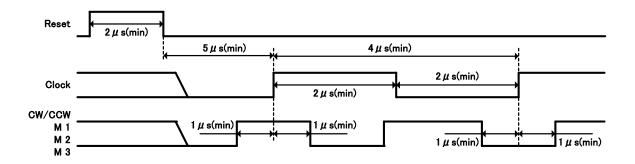
Operation Mode	M1	M2	M3	Remarks
2 Phase(1 Step)	L	L	L	Mode 8 only
2Phase(1 Step)	Н	L	L	Mode F only
1-2 Phase(1/2 Step)	L	Н	L	Mode 8, F
1-2 Phase(1/2 Step)	Н	Н	L	Mode F
W1-2 Phase(1/4 Step)	L	L	Н	Mode 4,8,C,F
W1-2 Phase(1/8 Step)	Н	L	Н	Mode 2,4,6,8,A,C,E,F
4W1-2 Phase(1/16 Step)	L	Н	Н	Mode 1 to F
Sleep Mode 2*	Н	Н	Н	

<sup>\*</sup> With a setup of a sleep mode 2, the operation is "Output Disable" and "Sequencer Hold". Sleep mode 2 operates without depending on the Clock.

#### Output Pin

Pin Name	High Level	Low Level
Mo	Half-Step Position (Mode 8)	-

#### Logic Input Timing Requirements



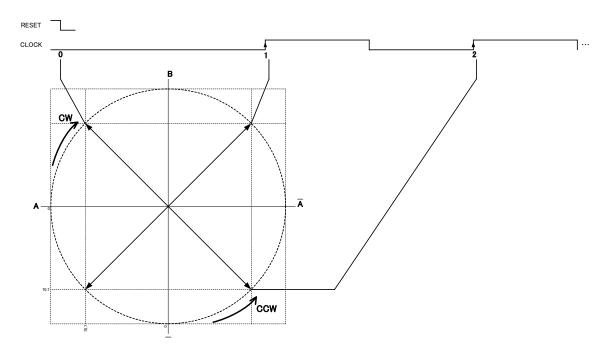


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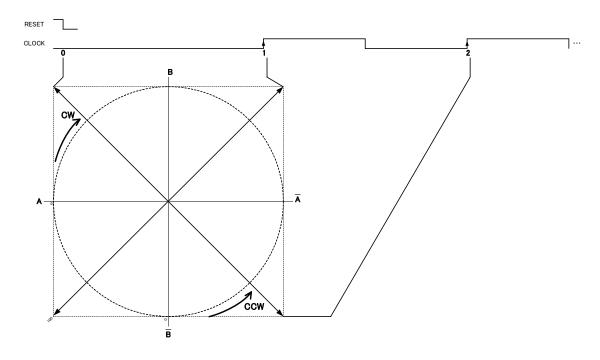
Step Sequencing Chart

### 2Phase

Mode: 8 M1: L, M2: L, M3: L



Mode: F M1: H, M2: L, M3: L

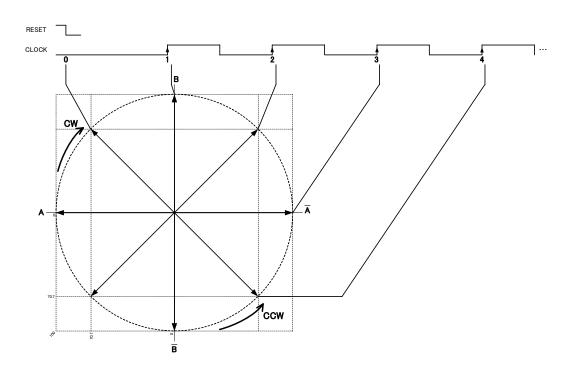




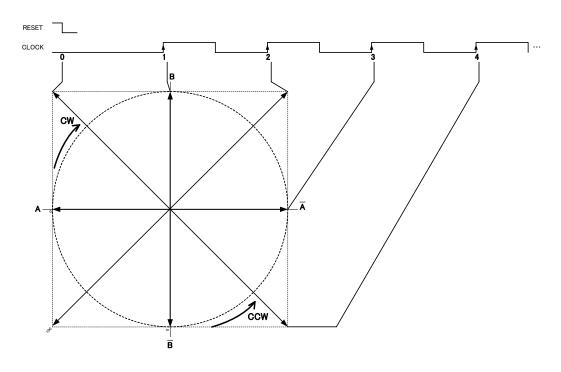
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1-2Phase

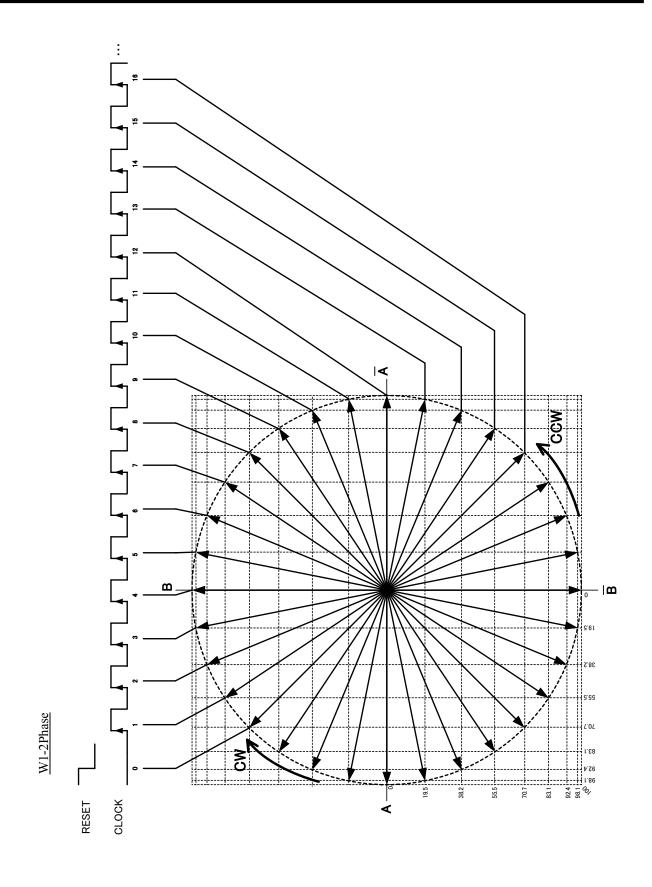
Mode: 8 <=> F M1: L, M2: H, M3: L



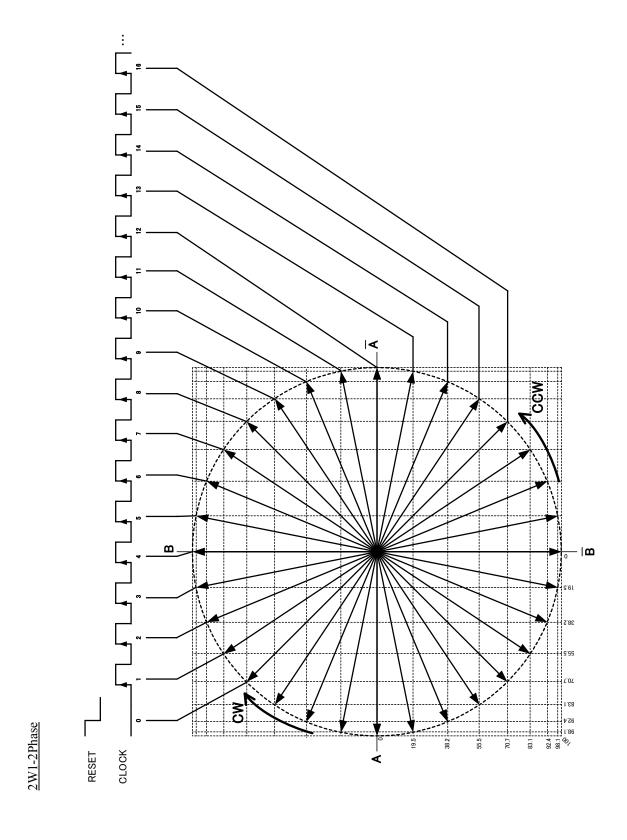
#### Mode: F M1:H, M2: H, M3: L



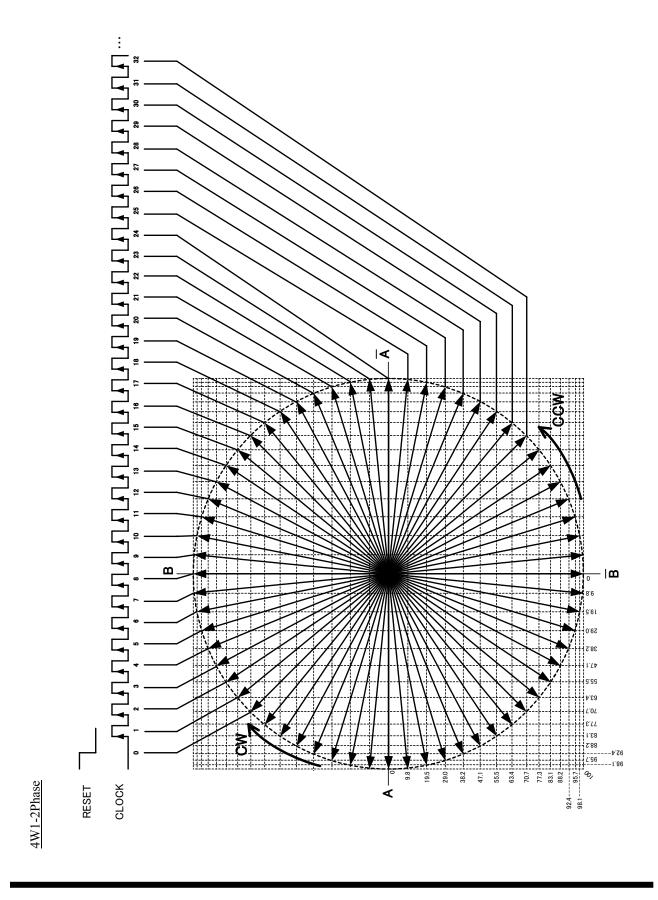
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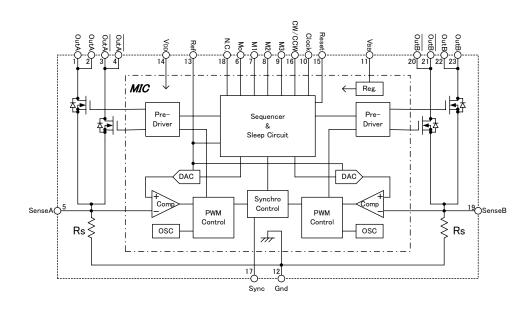
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### **Block diagram (Connection diagram)**

Internal functional block diagram

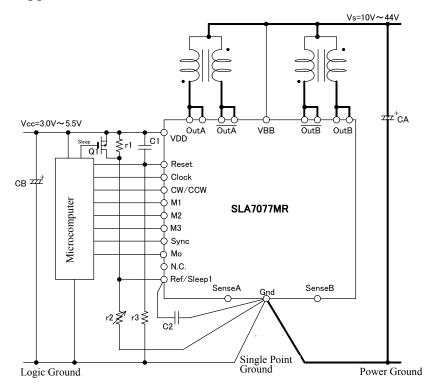


Pin Assignment (Terminal Functions)

Pin No.	Symbol	Function
1, 2	Out A	Phase A Output
3, 4	Out A/	Phase A/ Output
5	Sense A	Phase A Current Sense
6	Mo	Position Monitoring Output
7	M1	Micro-Stepping Operation Mode and
8	M2	Sleep Mode 2 Setting Input
9	M3	Sieep wode 2 Setting input
10	Clock	Step Clock Input
11	$V_{ m BB}$	Main Power Supply (For Motor)
12	Gnd	GND
13	Ref	Control Current and Sleep Mode 1
13	Kei	Setting Input.
14	$V_{ m DD}$	Logic Supply
15	Reset	Reset Input for Logic Circuit
16	CW/CCW	Forward / Reverse Switch Input
17	Sync	PWM Chopping Function Select Input
18	N.C.	Non Connection
19	Sense B	Phase B Current Sense
20, 21	Out B/	Phase B/ Output
22, 23	Out B	Phase B Output

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### **Example application circuit**



#### Reference constant

$$\begin{split} R_1 &= 10k\Omega & C_A &= 100\mu F/50V \\ R_2 &= 5.1k\Omega(VR) & C_B &= 10\mu F/10V \\ R_3 &= 10k\Omega & C_1 &= 0.1\mu F \end{split}$$

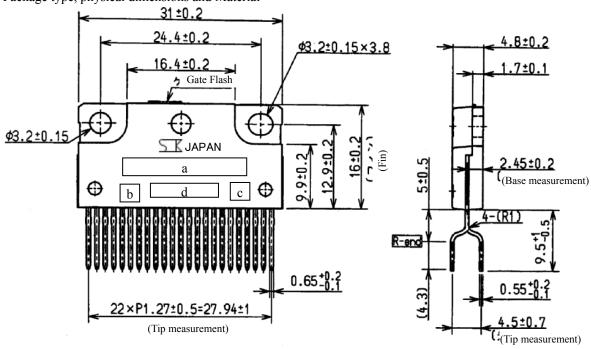
Take precautions to avoid noise on the V<sub>DD</sub> line:
 Switching noise from PCB traces, where high current flows, to the V<sub>DD</sub> line should be minimized because the noise level more than 0.5V on the V<sub>DD</sub> line may cause malfunctioning operation.

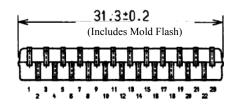
 The tip for avoiding such problem is to separate the logic GND (S-GND) and the power GND (P-GND) on the PCB, and then connect them together at IC GND pin (pin 12).

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### **Package information**

Package type, physical dimensions and Material





Dimensions in millimeters Material of terminal : Cu

Treatment of terminal: Ni planting + solder dip (Pb Free)

Appearance

The body shall be clean and shall not bear any stain, rust or flaw. Marking

The part number and lot number shall be clearly marked in white.

a. Part Number (1) SLA707xMR\* W B b. Part Number (2) (Marked per functions.)\* c. Part Number (3) (Marked per functions.)\* d. Lot Number 1st letter The last digit of year 2nd letter Month 1 to 9 : Arabic Numerals for Jan. to Sep. October: O November: N December: D 3rd &4th letter Day

01 to 31 : Arabic Numerals

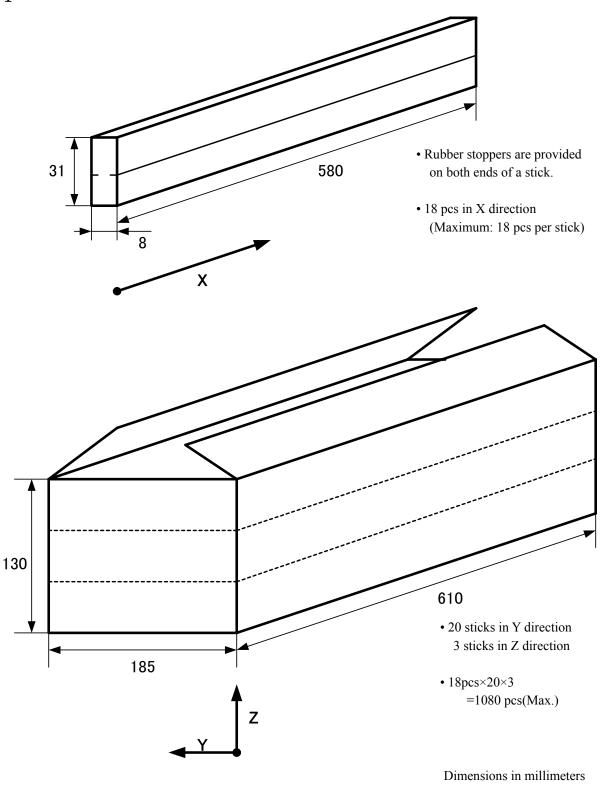
\* The letter x in Part Number (1) represents one number from 0 to 3 and 5 to 8 according to the combination of the current rating and sequencer.

The letter P, R, W, B represent the functions built-in. (No marking for non built-in functions.)

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### **Packing specifications**

1





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#### Cautions and warnings

The calculation of control current

SLA707xMR control current Io (at Mode F) is calculated as follows:

$$I_O = \frac{V_{REF}}{R_S}$$

Setting the REF voltage more than 2V activates the sleep mode 1 (all outputs are in OFF state). Even in this case, the internal logic circuit is alive.

Logic input/output (RESET, CLOCK, CW/CCW, M1, M2, M3, SYNC, Mo)

- The timing shown below shall comply with the "Logic input timing".
- -The rising edge timing of CW/CCW, M1, M2, M3 and CLOCK input
- -The RESET release timing (=the falling edge on RESET input) and the rising edge timing of CLOCK input
- \*In case the above does not comply with the "Logic input timing", the device may operate with an unexpected sequence.
- Be sure not to leave the logic inputs (RESET, CLOCK, CW/CCW, M1, M2, M3, SYNC) open. Be sure to connect the unused logic inputs to VDD or GND.
- \*In case any of the logic inputs are left "OPEN", malfunction may occur due to external noises.
- When the logic output (Mo) is not used, be sure to keep it "OPEN".
- \*In case it is connected to VDD or GND, it may cause the device's deterioration or/and breakdown.

Mounting on a heat sink

1) Recommended Mounting Torque (on an External Heat sink)

0.490 to 0.822N•m

2) Recommended Silicone

G746 {SHIN-ETSU CHEMICAL} YG6260 {TOSHIBA SILICONE}

SC102 {DOW CORNING TORAY SILICONE}



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#### Notice

This device has C-MOS inputs. Please note the following contents.

- When a static electricity is liable to be troublesome, especially in winter, be sure to control the room humidity properly.
- Be sure to take some proper measures for wirings from the IC input pins and for assembly processes in order not to apply static charges to IC leads. PC board pins should be shorted together to keep them in the same potential to avoid this kind of trouble.

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